

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|---|---|------------------|
| 1 | 7 | ("3850508" "4824698" "5216362" "5581194" "5977788" "6168551" "6326220" "6417032") | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:21 |
| 2 | 661 | semiconductor near4 (surface adj treatment) | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:23 |
| 3 | 308 | (semiconductor near4 (surface adj treatment)) and wafer | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:23 |
| 4 | 32 | ((semiconductor near4 (surface adj treatment)) and wafer) and (infrared or IR) | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:37 |
| 5 | 4 | ((((semiconductor near4 (surface adj treatment)) and wafer) and (infrared or IR)) and (desorb or desorption) | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:35 |
| 6 | 3 | ((semiconductor near4 (surface adj treatment)) and wafer) and (inversion adj condition) | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:37 |
| 7 | 3 | ((((semiconductor near4 (surface adj treatment)) and wafer) and (inversion adj condition)) and (infrared or IR) | USPAT; US-PGPUB; EPO; JPO; IBM_TDB | 2004/06/22 14:38 |